

# OKI Semiconductor ML9261A

Oki, Network Solutions for a Global Society

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# Preliminary

60-Bit Vacuum Fluorescent Display Tube Grid/Anode Driver

# **GENERAL DESCRIPTION**

The ML9261A is a monolithic IC designed for directly driving the grid and anode of the vacuum fluorescent display (VFD) tube. The device contains a 60-bit shift register, a 60-bit register circuit, and 60 VFD tube driving circuits on a single chip.

Display data is serially stored in the shift register at the rising edge of a clock pulse.

Setting the  $\overline{\text{CL}}$  pin low allows all the VFD tube driving circuits to be driven low, which makes it possible to set the display blanking.

Also, setting both of the  $\overline{CL}$  and CHG pins high allows all the VFD tube driving circuits to be driven high, which provides the easy testing of all lights after final assembly of a VFD tube panel.

## FEATURES

• Logic Supply Voltage (V <sub>CC</sub> ):	$+3.3 \text{ V} \pm 10\% \text{ or } +5.0 \text{ V} \pm 10\%$
• Driver Supply Voltage (V <sub>HV</sub> ):	+60 V
Driver Output Current	
I <sub>OHVH1</sub> (Only one driver output: "H"):	$-40 \text{ mA} (V_{\text{DISP}} = 40 \text{ V})$
I <sub>OHVH2</sub> (All the driver outputs: "H"):	$-120 \text{ mA} (V_{\text{DISP}} = 40 \text{ V})$
I <sub>OHVL</sub> : 1 mA	
• Directly connected to VFD tube by using push-p	ull output (Pull-down resistors are not needed)

• Data Transfer Speed: 4 MHz

• Package: 70-pin plastic SSOP (SSOP70-P-500-0.80-K) (Product names: ML9261AMB)

# **BLOCK DIAGRAM**





PIN CONFIGURATION (TOP VIEW)

70-Pin Plastic SSOP (SSOP70-P-500-0.80-K)

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#### **PIN DESCRIPTION**

Symbol	Туре	Description
CLK	I	Shift register clock input pin. Shift register reads data from DIN while the CLK pin is low and the data in the shift register is shifted from one stage to the next stage at the rising edge of the clock.
DIN	I	Serial data input pin of the shift register. Display data (positive logic) is input in the DIN pin in synchronization with clock.
DOUT	0	Serial data output pin of the shift register. Data is output from the DOUT pin in synchronization with the CLK signal.
LS	I	Latch strobe input pin. The contents of the parallel outputs (PO1 to PO60) of the shift register are read at the rising edge of LS (edge-triggered). When the CLK rises while LS is high, the parallel outputs (PO1 to PO60) and latch outputs (O1 to O60) go low.
CL	I	Clear input pin with a built-in pull-down resistor. The $\overline{CL}$ pin is normally set high. If the $\overline{CL}$ pin is high and the CHG pin is low, the driver outputs (HVO1 to HVO60) are in phase with the corresponding register outputs (O1 to O60). If the $\overline{CL}$ pin is high and the CHG pin is high, the driver outputs (HVO1 to HVO60) are high irrespective of the states of the register outputs. If the $\overline{CL}$ pin is set low, the driver outputs are driven low irrespective of the states of the CHG pin and register outputs. This allows display blanking to be set.
CHG	I	Input for testing (with a pull-down resistor). The $\overline{CL}$ pin is normally set low. If the CHG pin is low and the $\overline{CL}$ pin is high, the driver outputs (HVO1 to HVO60) are in phase with the corresponding register outputs (O1 to O60). If the CHG pin is low and the $\overline{CL}$ pin is low, the driver outputs (HVO1 to HVO60) are low irrespective of the states of the register outputs. If the CHG pin is set high, the driver outputs are driven high irrespective of the states of the register outputs. This provides the easy testing of all lights after final assembly.
VHO1-60	0	High voltage driver outputs for driving a VFD tube. If the CL pin is high and the CHG pin is low, the driver outputs are in phase with the corresponding register outputs (O1 to O60). The direct connection to the grid or anode of a VFD tube eliminates pull-down resistors.
V <sub>DISP</sub>		Power supply pin for VFD tube driver circuits
V <sub>DD</sub>		Power supply pin for logic
D-GND		GND pin for VFD tube driver circuits. Since the D-GND pin is not connected internally to the L-GND pin, connect these pins outside of the IC.
L-GND		GND pin for the logic circuits. Since the L-GND pin is not connected internally to the D-GND pin, connect thiese pins outside of the IC.

Parameter	Symbol	Condition	Rating	Unit
Supply Voltage (1) *	V <sub>DD</sub>	Applicable to logic supply pin	-0.3 to +6.5	V
Supply Voltage (2) *1, *	V <sub>DISP</sub>	Applicable to driver supply pin	-0.3 to +70	V
Input Voltage *	V <sub>IN</sub>	Applicable to all input pins	–0.3 to V <sub>DD</sub> +0.3	V
Output Voltage *	Vo	Applicable to DOUT	-0.3 to V <sub>DD</sub> +0.3	V
Output Current	lo	Applicable to HVO1 to HVO60	-50 to 0.0	mA
Withstand Output Voltage *1, *	V <sub>HVO</sub>	Applicable to HVO1 to HVO60	–0.3 to V <sub>DISP</sub> +0.3	V
Power Dissipation	PD	Ta ≤ 25°C	1.9	mW
Package Thermal Resistance *	R <sub>j-a</sub>	Ta > 25°C	68	°C/W
Storage Temperature	T <sub>STG</sub>	_	-55 to +150	°C

# **ABSOLUTE MAXIMUM RATINGS**

Notes: \*1 Supply Voltage for L-GND and D-GND \*2 Permanent damage may be caused if the voltage is supplied over the rating value. \*3 Package Thermal Resistance (between junction and ambient)

The junction temperature (T<sub>i</sub>) expressed by the equation indicated below should not exceed 150°C.

 $T_j = P \times R_{j-a} + Ta$  (P: Maximum power consumption)

#### **RECOMMENDED OPERATING CONDITIONS-1**

#### Unit Power Supply: 5.0 V (Typ.)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply (1)	V <sub>DD</sub>	—	4.5	5.0	5.5	V
Power Supply (2)	V <sub>DISP</sub>	—	20		60	V
"H" Input Voltage	V <sub>IH</sub>	Applicable to all inputs	$0.7 V_{DD}$		—	V
"L" Input Voltage	VIL	Applicable to all inputs	—		$0.3 V_{DD}$	V
Driver Output Current	I <sub>OHVH1</sub>	Only 1 output is ON.	—		-40	mA
Driver Output Current	I <sub>OHVH2</sub>	All outputs are ON.	—		-120	mA
CLK Frequency	f <sub>CLK</sub>	_	_		4.0	MHz
Operating Temperature	T <sub>OP</sub>	_	-40		+85	°C

# **RECOMMENDED OPERATING CONDITIONS-2**

# Unit Power Supply: 3.3 V (Typ.)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply (1)	V <sub>DD</sub>	—	3.0	3.3	3.6	V
Power Supply (2)	V <sub>DISP</sub>	—	20		60	V
"H" Input Voltage	V <sub>IH</sub>	Applicable to all inputs	$0.8 V_{DD}$		_	V
"L" Input Voltage	V <sub>IL</sub>	Applicable to all inputs	—		$0.2 V_{DD}$	V
Driver Output Current	I <sub>OHVH1</sub>	Only 1 output is ON.	_		-40	mA
Driver Output Current	I <sub>OHVH2</sub>	All outputs are ON.	_		-120	mA
CLK Frequency	f <sub>CLK</sub>	—	—	_	4.0	MHz
Operating Temperature	T <sub>OP</sub>	_	-40	_	+85	°C

# **ELECTRICAL CHARACTERISTICS**

#### **DC Characteristics-1**

$(V_{DD} = 4.5 \text{ to } 5.5 \text{ V}, V_{DISP} = 20 \text{ to } 60 \text{ V}, \text{ Ta} = -40 \text{ to}$								+85°C)
Parameter	Symbol	Applicable pin	Co	ondition	Min.	Тур.	Max.	Unit
"H" Input Voltage	V <sub>IH</sub>	All inputs		_	$0.7 V_{DD}$	_	_	V
"L" Input Voltage	VIL	All inputs		_	—	_	0.3 V <sub>DD</sub>	V
"L" Input Current	I <sub>IH1</sub>	DIN, CLK, LS	$V_{DD} = V_{DD}$	V <sub>IN</sub> = 5.5 V	-1.0		+1.0	μA
"H" Input Current	I <sub>IH2</sub>	CL, CHG	$V_{DD} = V_{DD}$	V <sub>IN</sub> = 5.5 V	5.0		80	μA
"L" Input Current	l <sub>IL</sub>	All inputs	$V_{DD} = 5.5$	5 V, V <sub>IN</sub> = 0 V	-1.0	_	+1.0	μΑ
Input Capacitance	CIN	All inputs	Та	= 25°C	_	15	—	pF
	V <sub>OH1</sub>	DOUT	I <sub>OH</sub> = -0.1 mA		V <sub>DD</sub> -1	_	_	V
"H" Output Voltage	V <sub>OH2</sub>	HVO1 to 60	V <sub>DISP</sub> = 40 V I <sub>OH</sub> = -40 mA		V <sub>DISP</sub> -4	_	_	V
	V <sub>OL1</sub>	DOUT	I <sub>OL</sub> =	= 0.1 mA	—	_	1.1	V
"L" Output Voltage	V <sub>OL2</sub>	HVO1 to 60		<sub>P</sub> = 40 V = 1 mA	_	_	3.0	V
	I <sub>DD1</sub>	V <sub>DD</sub>		All inputs: "L"	—		10.0	μA
Supply Current	I <sub>DD2</sub>	V <sub>DD</sub>	Noload	All inputs: "H"	_		10.0	μA
(Design Goal)	I <sub>DISP1</sub>	V <sub>DISP</sub>	No load	All inputs: "L"	_		70.0	μA
	I <sub>DISP2</sub>	V <sub>DISP</sub>		All inputs: "H"	—	—	70.0	μA

#### DC Characteristics-2

$(V_{DD} = 3.0 \text{ to } 3.6 \text{ V}, \text{ V}_{DISI})$						V, Ta = -	-40 to +85°	°C)
Parameter	Symbol	Applicable pin	Co	ndition	Min.	Тур.	Max.	Unit
"H" Input Voltage	VIH	All inputs		_	$0.8 V_{DD}$		_	V
"L" Input Voltage	V <sub>IL</sub>	All inputs		_	_	_	$0.2 V_{DD}$	V
"Ll" Input Current	I <sub>IH1</sub>	DIN, CLK, LS	$V_{DD} = V_{DD}$	V <sub>IN</sub> = 3.3 V	-1.0	_	+1.0	μΑ
"H" Input Current	I <sub>IH2</sub>	CL, CHG	V <sub>DD</sub> = '	V <sub>IN</sub> = 3.3 V	2.0		50	μΑ
"L" Input Current	IIL	All inputs	$V_{DD} = 3.3$	$V, V_{IN} = 0 V$	-1.0		+1.0	μA
Input Capacitance	CIN	All inputs	Та	= 25°C	_	15	_	pF
	V <sub>OH1</sub>	DOUT	I <sub>ОН</sub> =	I <sub>OH</sub> = -0.1 mA			_	V
"H" Output Voltage	V <sub>OH2</sub>	HVO1 to 60	V <sub>DISP</sub> = 40 V I <sub>OH</sub> = -40 mA		V <sub>DISP</sub> -4	_	_	V
	V <sub>OL1</sub>	DOUT	I <sub>OL</sub> =	I <sub>OL</sub> = 0.1 mA			1.1	V
"L" Output Voltage	V <sub>OL2</sub>	HVO1 to 60	5.0	V <sub>DISP</sub> = 40 V I <sub>OL</sub> = 1 mA		_	3.0	V
	I <sub>DD1</sub>	V <sub>DD</sub>		All inputs: "L"	_	_	10.0	μA
Supply Current	I <sub>DD2</sub>	V <sub>DD</sub>		All inputs: "H"	_		10.0	μA
(Design Goal)	I <sub>DISP1</sub>	V <sub>DISP</sub>	No load	All inputs: "L"	_		70.0	μΑ
	I <sub>DISP2</sub>	V <sub>DISP</sub>		All inputs: "H"	_		70.0	μΑ

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# AC Characteristics-1

	$(V_{DD} = 4.5 \text{ to } 5.5 \text{ V}, V_{DISP} = 20$	to 60 V, T	a = -40  to	) +85°C)	
Parameter	Symbol	Condition	Min.	Max.	Unit
CLK Pulse Width	t <sub>W</sub> (CLK)	—	80	150	ns
DIN Setup Time	t <sub>SU</sub> (D-CLK)	—	50	—	ns
DIN Hold Time	t <sub>H</sub> (CLK-D)	—	50	_	ns
CLK-LS Setup Time	t <sub>SU</sub> (CLK-LS)	—	50		ns
LS-CLK Setup Time	t <sub>SU</sub> (LS-CLK)	During normal operation	50	—	ns
	t <sub>SU</sub> (L-CLK)	At display data reset	50	—	ns
CLK-LS Hold Time	t <sub>H</sub> (CLK-L)	At display data reset	50		ns
LS-CHG Setup Time	t <sub>SU</sub> (LS-CHG)	CHG) —		—	ns
LS-CL Setup Time	t <sub>SU</sub> (LS- <u>CL</u> )	—	50	_	ns
LS Pulse Width	t <sub>W</sub> (LS)	—	80		ns
CHG Pulse Width	tw (CHG)	—	10	—	μs
CL Pulse Width	t <sub>W</sub> (CL)	—	10	_	μs
DOUT Delay time	t <sub>PD</sub> , t <sub>PRD</sub>	Load: 30 pF		50	ns
	t <sub>DLH</sub>	$V_{DISP} = 40 V$		2.0	μs
Driver Output Delay Time	t <sub>DHL</sub>	Load: 1.0 k $\Omega$ resistance in		2.0	μs
	t <sub>DRHL</sub>	parallel with 20 pF capacitance		2.0	μs
	t <sub>TLH</sub>	$V_{\text{DISP}} = 40 \text{ V}$	_	5.0	μs
Driver Output Slew Rate	t <sub>THL</sub>	Load: 1.0 k $\Omega$ resistance in parallel with 20 pF capacitance		5.0	μs

#### **AC Characteristics-2**

AC Characteristics-2					
		(V <sub>DD</sub> = 3.0 to 3.6 V, V <sub>DISP</sub> = 20	to 60 V, T	a = -40 to	+85°C)
Parameter	Symbol	Condition	Min.	Max.	Unit
CLK Pulse Width	t <sub>W</sub> (CLK)	—	80	150	ns
DIN Setup Time	t <sub>SU</sub> (D-CLK)	—	50	—	ns
DIN Hold Time	t <sub>H</sub> (CLK-D)	—	50	_	ns
CLK-LS Setup Time	t <sub>SU</sub> (CLK-LS)	—	50	_	ns
LS-CLK Setup Time	t <sub>SU</sub> (LS-CLK)	During normal operation	50	_	ns
LO-OLK Setup Time	t <sub>SU</sub> (L-CLK)	At display data reset	50	_	ns
CLK-LS Hold Time	t <sub>H</sub> (CLK-L)	At display data reset	50	_	ns
LS-CHG Setup Time	t <sub>s∪</sub> (LS-CHG)	_	50	_	ns
LS-CL Setup Time	t <sub>SU</sub> (LS- <u>CL</u> )	—	50	—	ns
LS Pulse Width	t <sub>w</sub> (LS)	—	80	—	ns
CHG Pulse Width	tw (CHG)	—	10	_	μs
CL Pulse Width	t <sub>W</sub> (CL)	—	10	—	μs
DOUT Delay time	t <sub>PD</sub> , t <sub>PRD</sub>	Load: 30 pF	—	50	ns
	t <sub>DLH</sub>	$V_{DISP} = 40 V$	—	3.0	μs
Driver Output Delay Time	t <sub>DHL</sub>	Load: 1.0 k $\Omega$ resistance in	—	3.0	μs
	t <sub>DRHL</sub>	parallel with 20 pF capacitance	_	3.0	μs
	t <sub>TLH</sub>	$V_{\text{DISP}} = 40 \text{ V}$		5.0	μs
Driver Output Slew Rate	t <sub>THL</sub>	Load: 1.0 k $\Omega$ resistance in parallel with 20 pF capacitance		5.0	μs

## $(V_{DD} = 4.5 \text{ to } 5.5 \text{ V}, V_{DISP} = 20 \text{ to } 60 \text{ V}, \text{ Ta} = -40 \text{ to } +85^{\circ}\text{C})$

#### TIMING DIAGRAMS

**Normal Display Operation** 



# **Display Data Reset Operation**



#### FUNCTIONAL DESCRIPTION

#### **Display Data Reset**

When the power is turned on, the shift register outputs (PO1 to PO60) and register outputs (O1 to O60) are indeterminate. Consequently the display of a VFD tube may flicker because unnecessary driver outputs go high. To prevent such flicker, it is required to perform the following operations.

- 1. Turn on the logic power supply while the  $\overline{CL}$  input is kept low.
- 2. Set the LS input high.

3. Switch the CLK input from a low level to a high level at least once.

By performing the above operations, all of the shift register outputs (PO1 to PO60) and register outputs (O1 to O60) are set low.

- 4. Enter display data.
- 5. Set the  $\overline{CL}$  input high.

#### Data Transfer

Write display data by using a serial transfer. Serial data is input in the shift register at the rising edge of a CLK input pulse. When the LS input rises, display data is written in the latch.

#### **Driver Output Control**

- 1. To turn on or off driver outputs by using display data transferred into the shift register, set the  $\overline{CL}$  input high and set the CHG input low.
- 2. To set all the driver outputs low, set the  $\overline{CL}$  input low.
- 3. To set all the driver outputs high, set the  $\overline{CL}$  input and CHG input high at a time.

#### **Function Table**

#### Shift register

	Input			Output				
CLK	DIN	LS	PO1	PO2	••••	PO59	PO60	DOUT
_	Н	L	Н	PO1n	••••	PO58n	PO59n	PO59n
	L	L	L	PO2n	••••	PO58n	PO59n	PO59n
	Х	L	PO1n	PO2n	••••	PO59n	PO60n	PO60n
	Х	Н	L	L	••••	L	L	L

#### X: Don't Care

PO1n to PO59n: PO1 to PO59 data just before CLOCK rises.

#### Register

Inp	out	Shift Register Parallel Out	Latch Output
CLK	LS	POm	Om
Х		Н	Н
Х		L	L
Х	┛	Х	No Change
_	Н	L	L

X: Don't Care, m: 1 to 60

#### Driver output

	Inp	out		Latch Output	Output
CL	CHG	CLK	LS	Om	HVOm
Н	L	Х	Х	Н	Н
Н	L	Х	Х	L	L
Н	Н	Х	Х	Х	Н
L	Х	Х	Х	Х	L
Х	Х		н	L	L

X: Don't Care, m: 1 to 60

#### **TEST CIRCUIT**



#### NOTES ON POWER APPLICATION

Connect L-GND and G-GND pins externally to provide the equal potential.

To prevent IC erroneous operation, turn on the logic power supply before turning on the driver power supply, and turn off the driver power supply before turning off the logic power supply.



## PACKAGE DIMENSIONS



Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

# **REVISION HISTORY**

	Document No.	Date	Page		
			Previous Edition	Current Edition	Description
	PEDL9261A-01	Jan. 22, 2002	-	-	Preliminary first edition

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